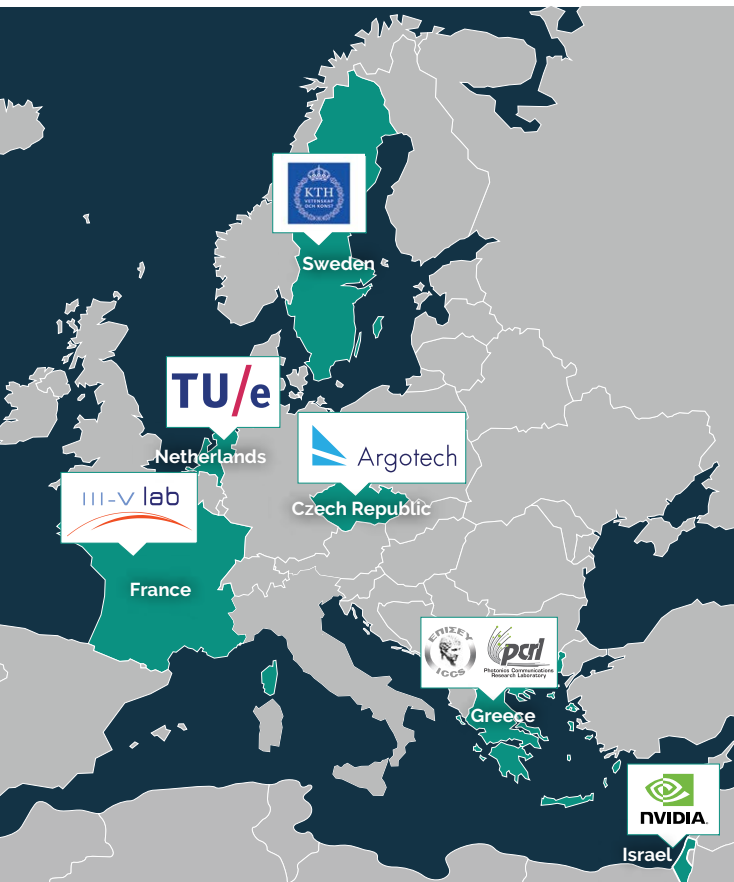


# Consortium



Supported by:



## MEET THE TEAM



6 partners



6 countries



3 Universities



2 Companies



1 Research Institute



PHOTONICS PUBLIC PRIVATE PARTNERSHIP



Project Title: Towards the neW era of 1.6 Tb/s System-InPackage transceivers for datacenter applications exploiting wafer-scale co-integration of InP membranes and InP-HBT electronics

Project Website: [www.ict-twilight.eu](http://www.ict-twilight.eu)

Project Coordinator: Hercules Avramopoulos  
Institute of Communication and Computer Systems - National Technical University of Athens (GR)

Duration: 01/12/2019 – 30/11/2022 (48 Months)

Partners: Institute of Communications and Computer Systems (GR) – Project Coordinator, Technische Universiteit Eindhoven (NL), III-V Lab (FR), Kungliga Tekniska Hogskolan (SE), Argotech (CZ), Mellanox Technologies (IL)

Grant Agreement no: 781471

Funding: ICT-05-2019 Application driven Photonics

EU Contribution: 5,080.621.25 €



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Towards the neW era of 1.6 Tb/s System-InPackage transceivers for datacenter applications exploiting wafer-scale co-integration of InP membranes and InP-HBT electronics



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## The Vision

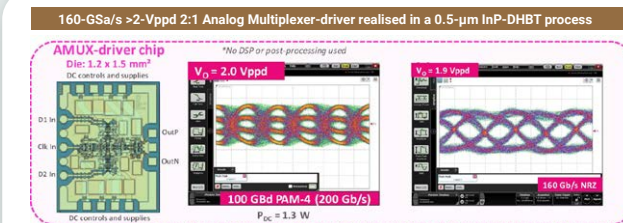
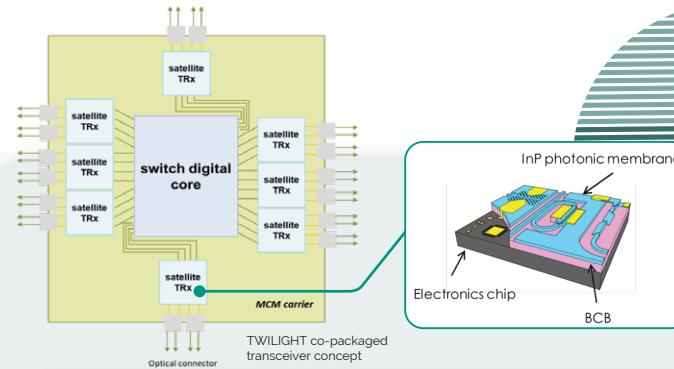
**TWILIGHT** will transform the datacenter environment by developing novel components and modules for 800 GbE and 1.6T co-packaged optical transceivers and optical space switches leveraging the combination of high speed InP membrane photonics and InP DHBT electronics technologies and novel co-integration and packaging schemes.

## Objectives

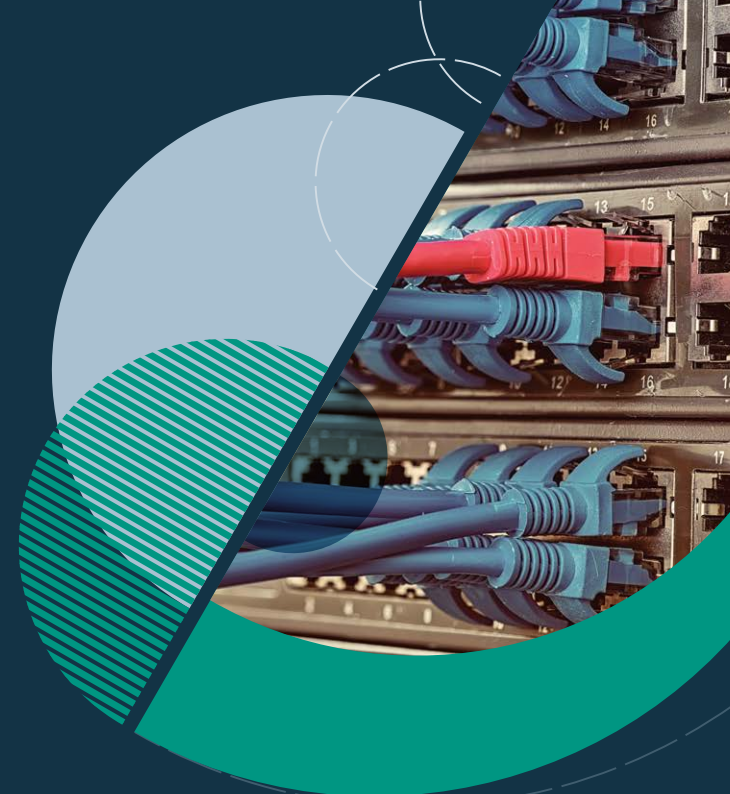
- ▶ **Objective 1:** Development of high performance InP photonic components on InP membranes enabling 112 Gbaud per lane transmission for intra- and inter- datacentre applications and ultra-fast large-scale integrated optical switches.
- ▶ **Objective 2:** Development of high-speed InP-HBT electronics components and ICs for interfacing with next generation 112G SERDES.
- ▶ **Objective 3:** Development of system-on-chip photonic platform based on the co-integration of actives and passives enabling complex functionalities.
- ▶ **Objective 4:** Towards wafer-scale co-integration of InP photonics and InP-HBT electronics for the development of optoelectronic engines with enhanced capabilities.
- ▶ **Objective 5:** Intimate integration of optoelectronic engine with ASIC for the development of system-in package (SiP) transceiver demonstrators for 1.6T intra- and inter- datacentre applications.
- ▶ **Objective 6:** Development of a programmable compact ultra-fast 4x4 and 16x16 optical space switches for low latency intra-datacentre connectivity.
- ▶ **Objective 7:** Performance evaluation of the developed TWILIGHT demonstrators under real network conditions and exploitation of project foreground.

## Optical transceiver technologies

- ▶ **100-GHz electro-absorption modulated lasers (EMLs) and UTC photodiode arrays** on InP membrane photonic integration technology platform.
- ▶ **110-GHz InP-DHBT 2:1 analog multiplexer-driver** with gain peaking and linear amplification at the transmitter (Tx) side.
- ▶ **100 GHz InP-DHBT low-noise linear transimpedance amplifier (TIA) and 1:2 analog demultiplexer** at the receiver (Rx) side.
- ▶ **>400-GHz fT and >500-GHz fMAX 0.5- $\mu$ m InP-DHBT process** with BVCE0>3.5 V for Tx and Rx InP-DHBT electronics integrated circuits
- ▶ **Close co-integration of photonics and electronics components (RF vias ~ 20- $\mu$ m length)** via full wafers eliminating parasitic effects and allowing for ultra-high speed operation.
- ▶ **Multi-Chip-Module (MCM) transceiver architecture comprising satellite transceiver chiplets** placed close to the ASIC switch chip.



R. Hersent et al., "160-GSa/s and-beyond 108-GHz-bandwidth over-2-Vppd output-swing 0.5- $\mu$ m InP DHBT 2:1 AMUX-driver for next generation optical communications", IEEE MICROWAVE AND WIRELESS COMPONENTS LETTERS, VOL. 32, NO. 6, JUNE 2022, June 2022, doi: 10.1109/LMWC.2022.3161706.



## Optical space switch technology

- ▶ Nanosecond scale response exploiting ultra-fast energy efficient and polarization insensitive InP membrane semiconductor optical amplifiers (SOAs).
- ▶ Scalable to large number of I/O ports.

## Impact

**TWILIGHT** comprises industry-driven consortium and is committed to make large impact on next generation datacenter upgrades targeting 800 GbE and 1.6T standards and leveraging more than 70% power consumption savings and cost 0.89€/Gb/s.